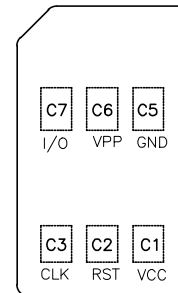
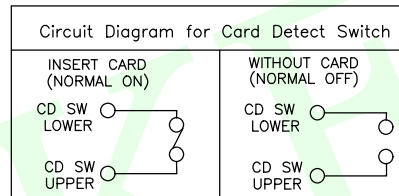
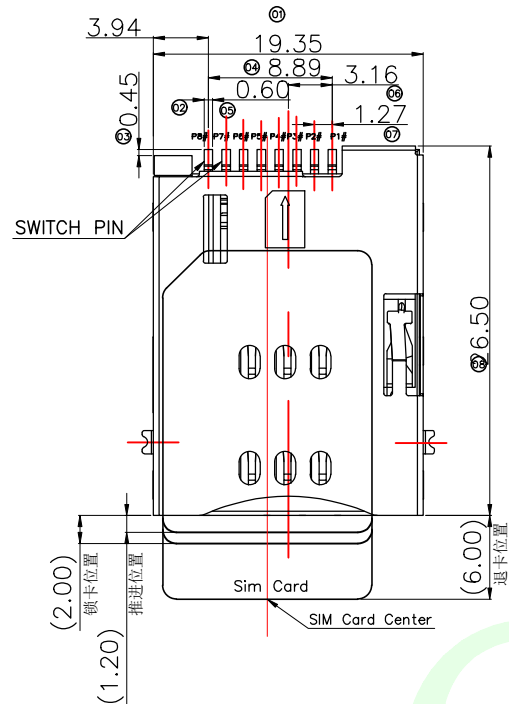
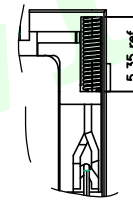


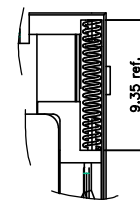
RoHS Compliant



SIM 示意图
芯片面朝下视图



工作状态



预压状态

NOTES:

1) MATERIAL:

HOUSING: LCP UL 94V-0
CONTACT: C5210R-H,T=0.15
SHELL: SUS201,T=0.15
MYLAR: POLYESTER

2) FINISH:

CONTACT: GOLD FLASH PLATED ON CONTACT AREA;
GOLD FLASH PLATING ON SOLDER TAILS, WITH
ENTIRE CONTACT UNDERPLATED 30u"Min, NICKEL
SHELL: 50u"Min. NICKEL UNDERPLATED OVERALL,
GOLD FLASH PLATED ON SOLDER TAILS

3) INFRARED REFLOW SOLDERING: 10sec. Min. at 260±10

4) PART NUMBER INFORMATION:

LCK-MS -213 H220 08- W L G

连晟欣 LCK

产品类别
MS: MINI SIM
SIM: MICRO SIM
NANO: NANO SIM

产品流水料号识别码

产品高度
H220: 2.20MM

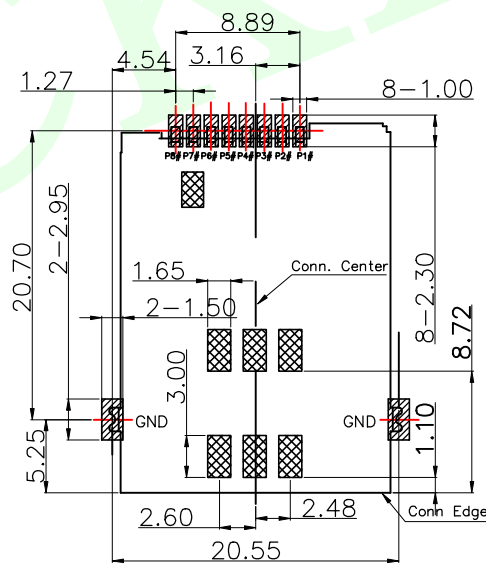
电镀规格
G: gold flash
G1: 1U
G3: 3U
(以此类推)

包装方式
L: 圆盘

有柱无柱
Y: 有柱
W: 无柱

产品PIN位
08: 8PIN

PIN NO.	DESCRIPTION
P1#	C1:VCC
P2#	C5:GND
P3#	C2:RST
P4#	C6:VPP
P5#	C3:CLK
P6#	C7:I/O
P7#	POL
P8#	DET



RECOMMENDED PCB LAYOUT(TOP VIEW)
GENERAL TOLERANCES:±0.05

SOLDER AREA
NONE CIRCUIT DIAGRAM AREA

MEASURE POINT:
QUADRANT POINT (QP)
TANGENCY POINT (TP)
INTERSECTION POINT (IP)

UNLESS OTHERWISE
SPECIFIED, TOLERANCE:
X. ±0.25
X.x ±0.20
X.xx ±0.15
ANGULAR ±3°

 联晟欣连接器 (深圳) 有限公司 Lianshengxin Connector (Shenzhen) Co., Ltd				TITLE: MINI SIM PUSH 2.2H 6+2P连续PIN 脚距5.25无柱			
DESIGN	Andy	DATE	2014.12.24	PART NO:	LCK-MS-213H22008-WLG	REV: 04	SCALE: 1:1
CHECKED		DATE		DRAWING NO:	102021005	SIZE: A4	SHEET: 1/1
APPROVED		DATE		UNIT:	mm		